ATTY DOCKET NO. CPAC 1029-4 ADJ. No. 10/681,833 PATENT JAN

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos KARNEZOS

Application No.: 10/681,833

Filed: October 8, 2003

Title: Semiconductor stacked multi-package module having inverted second package and electrically shielded first package

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 1, 2004.

igned Kaula Taulk Hurley

MAIL STOP AMENDMENT COMMISSIONER FOR PATENTS P.O BOX 1450 ALEXANDRIA, VA 22313-1450

**AMENDMENT** 

Dear Sir:

In response to the Office action mailed June 30, 2004, kindly amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

There are no amendments to the claims. A **Listing of Claims** is included for the Examiner's convenience, beginning on page 5 of this paper.

Amendments to the Drawings begin on page 9 of this paper and include both attached replacement sheets and annotated sheets showing changes.

Remarks begin on page 10 of this paper.

An Appendix including amended drawing figures is attached following page 15 of this paper.